# **74LVC623A**

# Octal transceiver with dual enable; 3-state Rev. 5 — 25 November 2011

Product data sheet

#### **General description** 1.

The 74LVC623A is an octal transceiver featuring non-inverting 3-state bus compatible outputs in both send and receive directions. This octal bus transceiver is designed for asynchronous two-way communication between data buses.

The control function implementation allows maximum flexibility in timing. This device allows data transmission from the An bus to the Bn bus or from the Bn bus to the An bus, depending upon the logic levels at the enable inputs (pins OEAB and OEBA). The enable inputs can be used to disable the device so that the buses are effectively isolated. The dual enable function configuration gives this transceiver the capability to store data by simultaneous enabling of pins OEAB and OEBA. Each output reinforces its input in this transceiver configuration. Thus, when both control inputs are enabled and all other data sources to the two sets of the bus lines are at high-impedance OFF-state, both sets of the bus lines will remain at their last states. The 8-bit codes appearing on the two sets of buses will be identical.

Inputs can be driven from either 3.3 V or 5 V devices. When disabled, up to 5.5 V can be applied to the outputs. These features allow the use of these devices as translators in mixed 3.3 V or 5 V applications.

#### 2. **Features and benefits**

- 5 V tolerant inputs and outputs for interfacing with 5 V logic
- Wide supply voltage range from 1.2 V to 3.6 V
- CMOS low power consumption
- Direct interface with TTL levels
- High-impedance when V<sub>CC</sub> = 0 V
- Complies with JEDEC standard:
  - ◆ JESD8-7A (1.65 V to 1.95 V)
  - ◆ JESD8-5A (2.3 V to 2.7 V)
  - ◆ JESD8-C/JESD36 (2.7 V to 3.6 V)
- ESD protection:
  - HBM JESD22-A114F exceeds 2000 V
  - MM JESD22-A115B exceeds 200 V
  - CDM JESD22-C101E exceeds 1000 V
- Specified from -40 °C to +85 °C and from -40 °C to +125 °C.



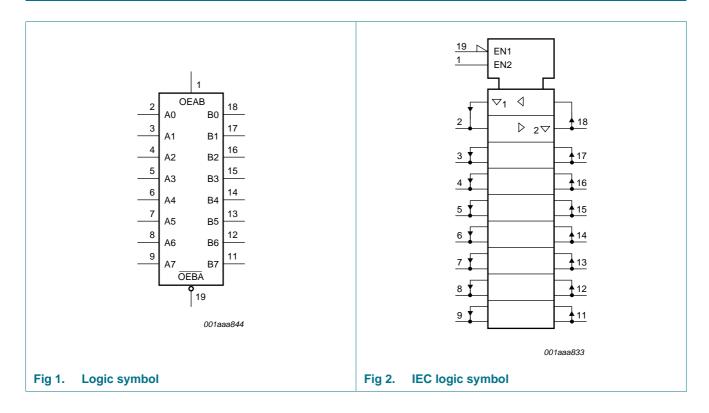
Octal transceiver with dual enable; 3-state

# 3. Ordering information

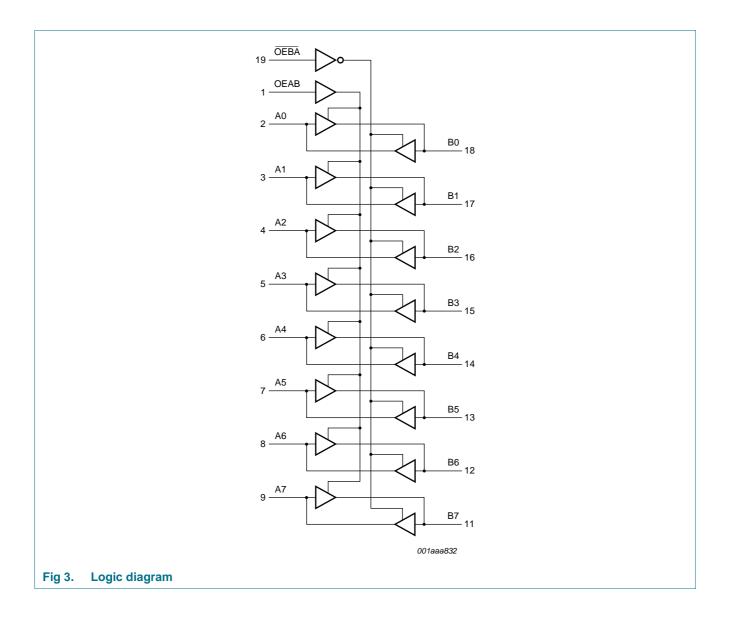
Table 1. Ordering information

Type number	Package	Package								
	Temperature range	Name	Description	Version						
74LVC623AD	–40 °C to +125 °C	SO20	plastic small outline package; 20 leads; body width 7.5 mm	SOT163-1						
74LVC623ADB	–40 °C to +125 °C	SSOP20	plastic shrink small outline package; 20 leads; body width 5.3 mm	SOT339-1						
74LVC623APW	–40 °C to +125 °C	TSSOP20	plastic thin shrink small outline package; 20 leads; body width 4.4 mm	SOT360-1						

# 4. Functional diagram



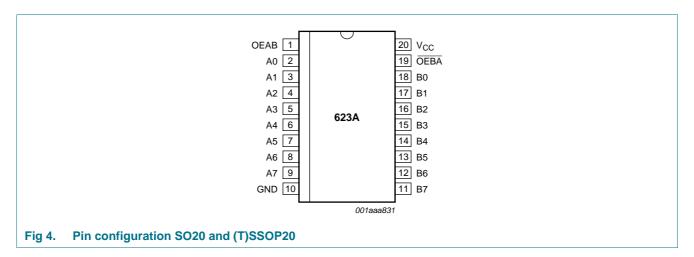
Octal transceiver with dual enable; 3-state



Octal transceiver with dual enable; 3-state

# 5. Pinning information

# 5.1 Pinning



# 5.2 Pin description

Table 2. Pin description

Pin	Symbol	Description
1	OEAB	output enable input
19	OEBA	output enable input (active LOW)
A[0:7]	2, 3, 4, 5, 6, 7, 8, 9	data input or output
B[0:7]	18, 17, 16, 15, 14, 13, 12, 11	data output or input
10	GND	ground (0 V)
20	V <sub>CC</sub>	supply voltage

Octal transceiver with dual enable; 3-state

# 6. Functional description

Table 3. Function table[1]

Input		Input or output	
OEAB	OEBA	An	Bn
L	L	An = Bn	input
Н	Н	input	Bn = An
L	Н	Z	Z
Н	L	An = Bn	input
		input	Bn = An

<sup>[1]</sup> H = HIGH voltage level; L = LOW voltage level; Z = high-impedance OFF-state

# 7. Limiting values

Table 4. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134). Voltages are referenced to GND (ground = 0 V).

Symbol	Parameter	Conditions	Min	Max	Unit
$V_{CC}$	supply voltage		-0.5	+6.5	V
V <sub>I</sub>	input voltage		<u>[1]</u> –0.5	+6.5	V
V <sub>O</sub>	output voltage	HIGH or LOW state	<sup>[2]</sup> -0.5	$V_{CC} + 0.5$	V
		3-state	<sup>[2]</sup> -0.5	+6.5	V
I <sub>IK</sub>	input clamping current	V <sub>I</sub> < 0 V	-50	-	mA
I <sub>OK</sub>	output clamping current	$V_O > V_{CC}$ or $V_O < 0 V$	-	±50	mA
I <sub>O</sub>	output current	$V_O = 0 V \text{ to } V_{CC}$	-	±50	mA
I <sub>CC</sub>	supply current		-	100	mA
$I_{GND}$	ground current		-100	-	mA
T <sub>stg</sub>	storage temperature		-65	±150	°C
P <sub>tot</sub>	total power dissipation	$T_{amb} = -40 ^{\circ}\text{C} \text{ to } +125 ^{\circ}\text{C}$	[3] _	500	mW

<sup>[1]</sup> The minimum input voltage ratings may be exceeded if the input current ratings are observed.

<sup>[2]</sup> The output voltage ratings may be exceeded if the output current ratings are observed.

<sup>[3]</sup> For SO20 package: above 70 °C P<sub>tot</sub> derates linearly with 8 mW/K.
For (T)SSOP20 packages: above 60 °C P<sub>tot</sub> derates linearly with 5.5 mW/K.

Octal transceiver with dual enable; 3-state

# 8. Recommended operating conditions

Table 5. Recommended operating conditions

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
$V_{CC}$	supply voltage		1.65	-	3.6	V
		functional	1.2	-	-	V
VI	input voltage		0	-	5.5	V
Vo	output voltage	HIGH or LOW state	0	-	$V_{CC}$	V
		3-state or V <sub>CC</sub> = 0 V	0	-	5.5	V
T <sub>amb</sub>	ambient temperature	in free air	-40	-	+125	°C
Δt/ΔV	input transition rise and fall rate	$V_{CC}$ = 1.65 V to 2.7 V	0	-	20	ns/V
		$V_{CC} = 2.7 \text{ V to } 3.6 \text{ V}$	0	-	10	ns/V

# 9. Static characteristics

Table 6. Static characteristics

At recommended operating conditions. Voltages are referenced to GND (ground = 0 V).

Symbol	Parameter	Conditions	-40	°C to +8	35 °C	-40 °C to	+125 °C	Unit
			Min	Typ[1]	Max	Min	Max	
V <sub>IH</sub>	HIGH-level	V <sub>CC</sub> = 1.2 V	1.08	-	-	1.08	-	٧
	input voltage	V <sub>CC</sub> = 1.65 V to 1.95 V	$0.65 \times V_{CC}$	-	-	$0.65 \times V_{CC}$	-	V
		V <sub>CC</sub> = 2.3 V to 2.7 V	1.7	-	-	1.7	-	V
		V <sub>CC</sub> = 2.7 V to 3.6 V	2.0	-	-	2.0	-	V
V <sub>IL</sub>	LOW-level	V <sub>CC</sub> = 1.2 V	-	-	0.12	-	0.12	V
	input voltage	V <sub>CC</sub> = 1.65 V to 1.95 V	-	-	$0.35 \times V_{CC}$	-	$0.35 \times V_{CC}$	V
		V <sub>CC</sub> = 2.3 V to 2.7 V	-	-	0.7	-	0.7	V
		V <sub>CC</sub> = 2.7 V to 3.6 V	-	-	0.8	-	0.8	V
V <sub>OH</sub>	HIGH-level	$V_I = V_{IH}$ or $V_{IL}$						
	output voltage	$I_O = -100 \mu A;$ $V_{CC} = 1.65 \text{ V to } 3.6 \text{ V}$	V <sub>CC</sub> - 0.2	-	-	V <sub>CC</sub> - 0.3	-	V
		$I_{O} = -4 \text{ mA}; V_{CC} = 1.65 \text{ V}$	1.2	-	-	1.05	-	V
		$I_{O} = -8 \text{ mA}; V_{CC} = 2.3 \text{ V}$	1.8	-	-	1.65	-	V
		$I_{O} = -12 \text{ mA}; V_{CC} = 2.7 \text{ V}$	2.2	-	-	2.05	-	V
		$I_{O} = -18 \text{ mA}; V_{CC} = 3.0 \text{ V}$	2.4	-	-	2.25	-	V
		$I_{O} = -24 \text{ mA}; V_{CC} = 3.0 \text{ V}$	2.2	-	-	2.0	-	V
V <sub>OL</sub>	LOW-level	$V_I = V_{IH}$ or $V_{IL}$						
	output voltage	$I_O = 100 \mu A;$ $V_{CC} = 1.65 \text{ V to } 3.6 \text{ V}$	-	-	0.2	-	0.3	V
		$I_O = 4 \text{ mA}; V_{CC} = 1.65 \text{ V}$	-	-	0.45	-	0.65	٧
		$I_O = 8 \text{ mA}; V_{CC} = 2.3 \text{ V}$	-	-	0.6	-	0.8	٧
		$I_O = 12 \text{ mA}; V_{CC} = 2.7 \text{ V}$	-	-	0.4	-	0.6	V
		$I_O = 24 \text{ mA}; V_{CC} = 3.0 \text{ V}$	-	-	0.55	-	0.8	V
l <sub>l</sub>	input leakage current	$V_{CC}$ = 3.6 V; $V_I$ = 5.5 V or GND	-	±0.1	±5	-	±20	μА

74LVC623A

All information provided in this document is subject to legal disclaimers.

© NXP B.V. 2011. All rights reserved.

Octal transceiver with dual enable; 3-state

Table 6. Static characteristics ...continued

At recommended operating conditions. Voltages are referenced to GND (ground = 0 V).

	=	•							
Symbol	Parameter	Conditions	-4	0 °C to +	85 °C	–40 °C t	-40 °C to +125 °C		
			Min	Typ[1]	Max	Min	Max		
I <sub>OZ</sub> [2]	OFF-state output current	$V_I = V_{IH}$ or $V_{IL}$ ; $V_{CC} = 3.6$ V; $V_O = 5.5$ V or GND;	-	0.1	±5	-	±20	μΑ	
l <sub>OFF</sub>	power-off leakage current	$V_{CC} = 0 \text{ V}; V_{I} \text{ or } V_{O} = 5.5 \text{ V}$	-	0.1	±10	-	±20	μА	
I <sub>CC</sub>	supply current	$V_{CC} = 3.6 \text{ V}; V_I = V_{CC} \text{ or GND}; I_O = 0 \text{ A}$	-	0.1	10	-	40	μΑ	
$\Delta I_{CC}$	additional supply current	per input pin; $V_{CC} = 2.7 \text{ V to } 3.6 \text{ V};$ $V_I = V_{CC} - 0.6 \text{ V};$ $I_O = 0 \text{ A}$	-	5	500	-	5000	μА	
C <sub>I</sub>	input capacitance	$V_{CC} = 0 \text{ V to } 3.6 \text{ V};$ $V_{I} = \text{GND to } V_{CC}$	-	4.0	-	-	-	pF	
C <sub>I/O</sub>	input/output capacitance	$V_{CC} = 0 \text{ V to } 3.6 \text{ V};$ $V_{I} = \text{GND to } V_{CC}$	-	10.0	-	-	-	pF	

<sup>[1]</sup> All typical values are measured at  $V_{CC}$  = 3.3 V (unless stated otherwise) and  $T_{amb}$  = 25 °C.

# 10. Dynamic characteristics

Table 7. Dynamic characteristics

Voltages are referenced to GND (ground = 0 V). For test circuit see Figure 8.

Symbol	Parameter	Conditions		-40	°C to +8	5 °C	-40 °C to +125 °C		Unit
				Min	Typ[1]	Max	Min	Max	
$t_{pd}$	propagation	An to Bn; Bn to An; see Figure 5	[2]						
	delay	V <sub>CC</sub> = 1.2 V		-	19	-	-	-	ns
		$V_{CC} = 1.65 \text{ V to } 1.95 \text{ V}$		1.7	6.4	13.5	1.7	14.2	ns
		$V_{CC} = 2.3 \text{ V to } 2.7 \text{ V}$		1.5	3.4	6.7	1.5	7.4	ns
		V <sub>CC</sub> = 2.7 V		1.5	3.4	5.7	1.5	7.5	ns
		V <sub>CC</sub> = 3.0 V to 3.6 V		1.0	2.9	5.2	1.0	6.5	ns
t <sub>en</sub>	enable time	OEAB to Bn; see Figure 6	[2]						
		V <sub>CC</sub> = 1.2 V		-	26	-	-	-	ns
		V <sub>CC</sub> = 1.65 V to 1.95 V		2.7	8.7	17.0	2.7	17.9	ns
		$V_{CC} = 2.3 \text{ V to } 2.7 \text{ V}$		2.2	4.8	8.9	2.2	9.8	ns
		V <sub>CC</sub> = 2.7 V		1.5	4.2	6.9	1.5	9.0	ns
		$V_{CC} = 3.0 \text{ V to } 3.6 \text{ V}$		1.0	3.9	6.6	1.0	8.5	ns
		OEBA to An; see Figure 7	[2]						
		V <sub>CC</sub> = 1.2 V		-	26	-	-	-	ns
		V <sub>CC</sub> = 1.65 V to 1.95 V		2.6	8.1	17.0	2.6	17.9	ns
		V <sub>CC</sub> = 2.3 V to 2.7 V		2.2	4.5	8.9	2.2	9.8	ns
		V <sub>CC</sub> = 2.7 V		1.5	4.6	7.5	1.5	9.5	ns
		$V_{CC} = 3.0 \text{ V to } 3.6 \text{ V}$		1.0	3.6	6.6	1.0	8.5	ns

74LVC623A

All information provided in this document is subject to legal disclaimers.

© NXP B.V. 2011. All rights reserved.

<sup>[2]</sup> For transceivers, the parameter  $I_{\mbox{\scriptsize OZ}}$  includes the input leakage current.

## Octal transceiver with dual enable; 3-state

 Table 7.
 Dynamic characteristics ...continued

Voltages are referenced to GND (ground = 0 V). For test circuit see <u>Figure 8</u>.

Symbol	Parameter	Conditions		-40	°C to +8	5 °C	-40 °C to	+125 °C	Unit
			-	Min	Typ[1]	Max	Min	Max	
t <sub>dis</sub>	disable time	OEAB to Bn; see Figure 6	<u>[2]</u>						
		V <sub>CC</sub> = 1.2 V		-	12	-	-	-	ns
		$V_{CC} = 1.65 \text{ V to } 1.95 \text{ V}$		2.3	4.7	10.5	2.3	11.1	ns
		$V_{CC} = 2.3 \text{ V to } 2.7 \text{ V}$		1.0	2.6	5.7	1.0	6.4	ns
		V <sub>CC</sub> = 2.7 V		1.5	4.2	6.2	1.5	8.0	ns
		$V_{CC} = 3.0 \text{ V to } 3.6 \text{ V}$		1.0	3.2	5.5	1.0	7.0	ns
		OEBA to An; see Figure 7	[2]						
		V <sub>CC</sub> = 1.2 V		-	11	-	-	-	ns
		$V_{CC} = 1.65 \text{ V to } 1.95 \text{ V}$		3.6	5.2	10.1	3.6	10.7	ns
		$V_{CC} = 2.3 \text{ V to } 2.7 \text{ V}$		1.0	2.9	5.5	1.0	6.1	ns
		$V_{CC} = 2.7 \text{ V}$		1.5	3.7	5.5	1.5	7.0	ns
		$V_{CC} = 3.0 \text{ V to } 3.6 \text{ V}$		1.0	3.4	5.3	1.0	7.0	ns
t <sub>sk(o)</sub>	output skew time	$V_{CC} = 3.0 \text{ V to } 3.6 \text{ V}$	[3]	-	-	1.0	-	1.5	ns
$C_{PD}$	power dissipation	per input; $V_I = GND$ to $V_{CC}$	[4]						
	capacitance	$V_{CC} = 1.65 \text{ V to } 1.95 \text{ V}$		-	11.9	-	-	-	pF
		$V_{CC} = 2.3 \text{ V to } 2.7 \text{ V}$		-	15.5	-	-	-	pF
		$V_{CC} = 3.0 \text{ V to } 3.6 \text{ V}$		-	18.8	-	-	-	pF

<sup>[1]</sup> Typical values are measured at  $T_{amb}$  = 25 °C and  $V_{CC}$  = 1.2 V, 1.8 V, 2.5 V, 2.7 V, and 3.3 V respectively.

 $t_{dis}$  is the same as  $t_{PLZ}$  and  $t_{PHZ}$ .

[4]  $C_{PD}$  is used to determine the dynamic power dissipation ( $P_D$  in  $\mu W$ ).

$$P_D = C_{PD} \times V_{CC}^2 \times f_i \times N + \Sigma (C_L \times V_{CC}^2 \times f_o)$$
 where:

 $f_i$  = input frequency in MHz;  $f_o$  = output frequency in MHz

 $C_L$  = output load capacitance in pF

V<sub>CC</sub> = supply voltage in Volts

N = number of inputs switching

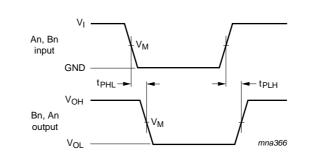
 $\Sigma (C_L \times V_{CC}{}^2 \times f_o)$  = sum of the outputs

<sup>[2]</sup>  $t_{pd}$  is the same as  $t_{PLH}$  and  $t_{PHL}$ .  $t_{en}$  is the same as  $t_{PZL}$  and  $t_{PZH}$ .

<sup>[3]</sup> Skew between any two outputs of the same package switching in the same direction. This parameter is guaranteed by design.

Octal transceiver with dual enable; 3-state

# 11. Waveforms



 $V_M = 1.5 \text{ V at } V_{CC} \ge 2.7 \text{ V};$ 

 $V_M = 0.5 \times V_{CC}$  at  $V_{CC} < 2.7$  V.

 $V_{OL}$  and  $V_{OH}$  are typical output voltage levels that occur with the output load.

Fig 5. The inputs An, Bn to outputs Bn, An propagation delays

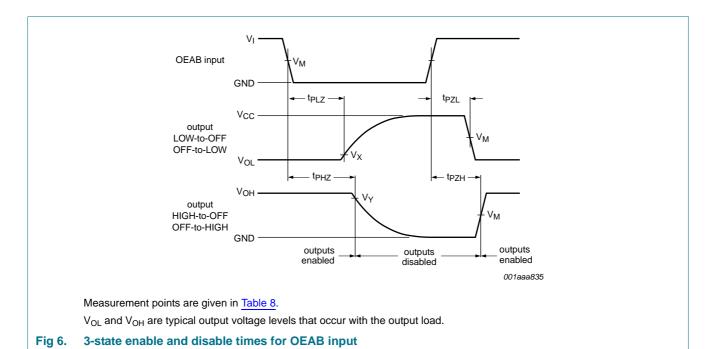
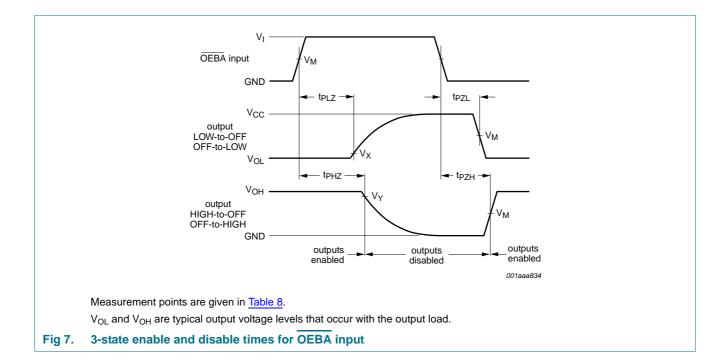


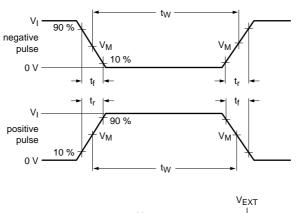
Table 8. Measurement points

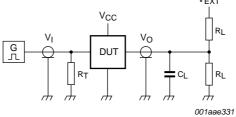
Supply voltage	Input	Output					
V <sub>CC</sub>	V <sub>M</sub>	V <sub>M</sub>	V <sub>X</sub>	V <sub>Y</sub>			
< 2.7 V	$0.5 \times V_{CC}$	$0.5 \times V_{CC}$	V <sub>OL</sub> + 0.15 V	V <sub>OH</sub> – 0.15 V			
≥ 2.7 V	1.5 V	1.5 V	V <sub>OL</sub> + 0.3 V	V <sub>OH</sub> – 0.3 V			

### Octal transceiver with dual enable; 3-state



### Octal transceiver with dual enable; 3-state





Test data is given in Table 9.

Definitions for test circuit:

R<sub>L</sub> = Load resistance.

 $C_L$  = Load capacitance including jig and probe capacitance.

 $R_T$  = Termination resistance should be equal to output impedance  $Z_0$  of the pulse generator.

 $V_{EXT}$  = External voltage for measuring switching times.

Fig 8. Test circuit for measuring switching times

Table 9. Test data

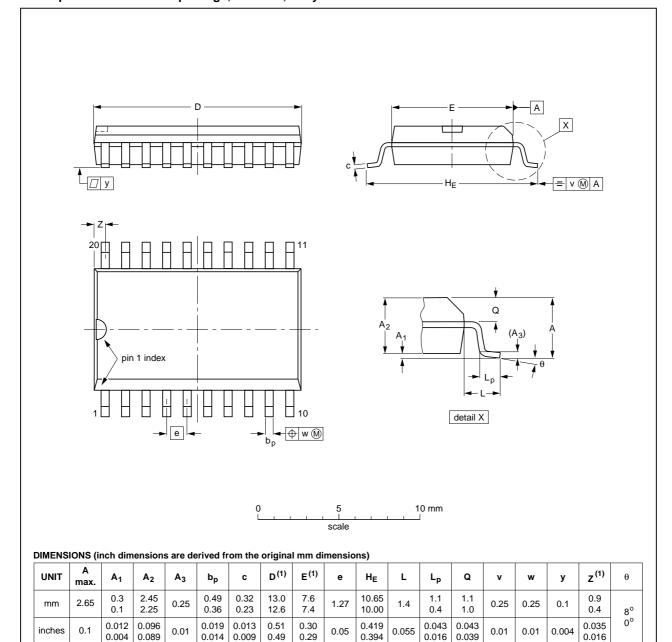
Supply voltage	Input	Input		Load		V <sub>EXT</sub>		
	$V_{l}$ $t_{r}, t_{f}$ $C_{L}$ $R_{L}$		t <sub>PLH</sub> , t <sub>PHL</sub>	$t_{PLZ}, t_{PZL}$	t <sub>PHZ</sub> , t <sub>PZH</sub>			
1.2 V	$V_{CC}$	≤ 2 ns	30 pF	1 k $\Omega$	open	$2\times V_{CC}$	GND	
1.65 V to 1.95 V	$V_{CC}$	≤ 2 ns	30 pF	1 kΩ	open	$2\times V_{CC}$	GND	
2.3 V to 2.7 V	$V_{CC}$	≤ 2 ns	30 pF	$500 \Omega$	open	$2\times V_{CC}$	GND	
2.7 V	2.7 V	≤ 2.5 ns	50 pF	$500 \Omega$	open	$2\times V_{CC}$	GND	
3.0 V to 3.6 V	2.7 V	≤ 2.5 ns	50 pF	$500 \Omega$	open	$2\times V_{CC}$	GND	

### Octal transceiver with dual enable; 3-state

# 12. Package outline

### SO20: plastic small outline package; 20 leads; body width 7.5 mm

SOT163-1



### Note

1. Plastic or metal protrusions of 0.15 mm (0.006 inch) maximum per side are not included.

OUTLINE		REFER	EUROPEAN	ISSUE DATE		
VERSION	IEC	JEDEC	JEITA		PROJECTION	
SOT163-1	075E04	MS-013				<del>99-12-27</del> 03-02-19

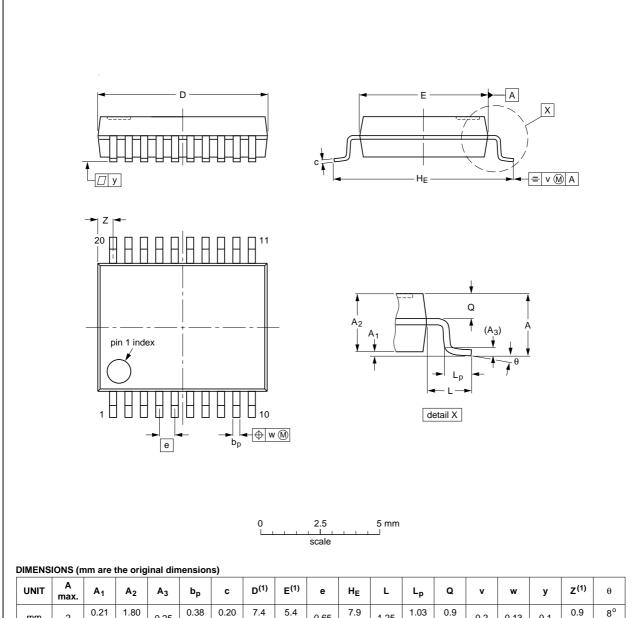
Fig 9. Package outline SOT163-1 (SO20)

74LVC623A

Octal transceiver with dual enable; 3-state

# SSOP20: plastic shrink small outline package; 20 leads; body width 5.3 mm

SOT339-1



	,, ,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,					٠,												
UNIT	A max.	A <sub>1</sub>	A <sub>2</sub>	A <sub>3</sub>	bp	С	D <sup>(1)</sup>	E <sup>(1)</sup>	е	HE	L	Lp	Q	v	w	у	Z <sup>(1)</sup>	θ
mm	2	0.21 0.05	1.80 1.65	0.25	0.38 0.25	0.20 0.09	7.4 7.0	5.4 5.2	0.65	7.9 7.6	1.25	1.03 0.63	0.9 0.7	0.2	0.13	0.1	0.9 0.5	8° 0°

### Note

1. Plastic or metal protrusions of 0.2 mm maximum per side are not included.

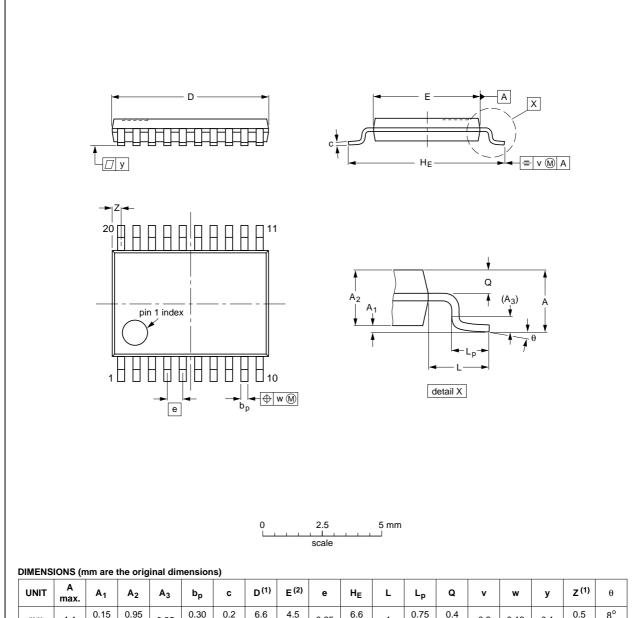
OUTLINE		REFER	EUROPEAN	ISSUE DATE			
VERSION	IEC	JEDEC	JEITA		PROJECTION	ISSUE DATE	
SOT339-1		MO-150				<del>99-12-27</del> 03-02-19	

Fig 10. Package outline SOT339-1 (SSOP20)

Octal transceiver with dual enable; 3-state

TSSOP20: plastic thin shrink small outline package; 20 leads; body width 4.4 mm

SOT360-1



UNIT	A max.	A <sub>1</sub>	A <sub>2</sub>	A <sub>3</sub>	bp	С	D <sup>(1)</sup>	E <sup>(2)</sup>	е	HE	L	Lp	ø	v	w	у	Z <sup>(1)</sup>	θ
mm	1.1	0.15 0.05	0.95 0.80	0.25	0.30 0.19	0.2 0.1	6.6 6.4	4.5 4.3	0.65	6.6 6.2	1	0.75 0.50	0.4 0.3	0.2	0.13	0.1	0.5 0.2	8° 0°

- 1. Plastic or metal protrusions of 0.15 mm maximum per side are not included.
- 2. Plastic interlead protrusions of 0.25 mm maximum per side are not included.

OUTLINE		REFER	EUROPEAN	ISSUE DATE			
VERSION	IEC	JEDEC	JEITA		PROJECTION	ISSUE DATE	
SOT360-1		MO-153				<del>99-12-27</del> 03-02-19	
							-

Fig 11. Package outline SOT 360-1 (TSSOP20)

Octal transceiver with dual enable; 3-state

# 13. Abbreviations

### Table 10. Abbreviations

Acronym	Description
CDM	Charged Device Model
DUT	Device Under Test
ESD	ElectroStatic Discharge
НВМ	Human Body Model
MM	Machine Model
TTL	Transistor-Transistor Logic

# 14. Revision history

# Table 11. Revision history

74LVC623A v.5  20111125  Product data sheet - 74LVC623A v.4  Modifications:  Typographical errors corrected  74LVC623A v.4  20111107  Product data sheet - 74LVC623A v.3  Modifications:  The format of this document has been redesigned to comply with the new identity guidelines NXP Semiconductors.  Legal texts have been adapted to the new company name where appropriate.  Table 4, Table 5, Table 6, Table 7, and Table 9: values added for lower voltage ranges.  DHVQFN package added to Section 3 and Section 12.  74LVC623A v.2										
Modifications:  • Typographical errors corrected  74LVC623A v.4  20111107  Product data sheet - 74LVC623A v.3  Modifications:  • The format of this document has been redesigned to comply with the new identity guidelines NXP Semiconductors.  • Legal texts have been adapted to the new company name where appropriate.  • Table 4, Table 5, Table 6, Table 7, and Table 9: values added for lower voltage ranges.  • DHVQFN package added to Section 3 and Section 12.  74LVC623A v.3  20040506  Product specification - 74LVC623A v.2	Document ID	Release date	Data sheet status	Change notice	Supersedes					
74LVC623A v.4  20111107 Product data sheet - 74LVC623A v.3  Modifications:  The format of this document has been redesigned to comply with the new identity guidelines NXP Semiconductors.  Legal texts have been adapted to the new company name where appropriate.  Table 4, Table 5, Table 6, Table 7, and Table 9: values added for lower voltage ranges.  DHVQFN package added to Section 3 and Section 12.  74LVC623A v.3  74LVC623A v.2	74LVC623A v.5	20111125	Product data sheet	-	74LVC623A v.4					
<ul> <li>Modifications:</li> <li>The format of this document has been redesigned to comply with the new identity guidelines NXP Semiconductors.</li> <li>Legal texts have been adapted to the new company name where appropriate.</li> <li>Table 4, Table 5, Table 6, Table 7, and Table 9: values added for lower voltage ranges.</li> <li>DHVQFN package added to Section 3 and Section 12.</li> <li>74LVC623A v.3</li> <li>74LVC623A v.2</li> </ul>	Modifications:	<ul> <li>Typographical</li> </ul>	errors corrected							
NXP Semiconductors.  • Legal texts have been adapted to the new company name where appropriate.  • <u>Table 4</u> , <u>Table 5</u> , <u>Table 6</u> , <u>Table 7</u> , and <u>Table 9</u> : values added for lower voltage ranges.  • DHVQFN package added to <u>Section 3</u> and <u>Section 12</u> .  74LVC623A v.3  20040506  Product specification - 74LVC623A v.2	74LVC623A v.4	20111107	Product data sheet	-	74LVC623A v.3					
<ul> <li>Table 4, Table 5, Table 6, Table 7, and Table 9: values added for lower voltage ranges.</li> <li>DHVQFN package added to Section 3 and Section 12.</li> <li>74LVC623A v.3</li> <li>20040506</li> <li>Product specification - 74LVC623A v.2</li> </ul>	Modifications:	<ul> <li>The format of this document has been redesigned to comply with the new identity guidelines of NXP Semiconductors.</li> </ul>								
<ul> <li>DHVQFN package added to <u>Section 3</u> and <u>Section 12</u>.</li> <li>74LVC623A v.3 20040506 Product specification - 74LVC623A v.2</li> </ul>		<ul> <li>Legal texts ha</li> </ul>	ve been adapted to the new	company name where	appropriate.					
74LVC623A v.3 20040506 Product specification - 74LVC623A v.2		• Table 4, Table	5, Table 6, Table 7, and Tab	le 9: values added for	lower voltage ranges.					
		<ul> <li>DHVQFN package added to <u>Section 3</u> and <u>Section 12</u>.</li> </ul>								
74LVC623A v.2 19980729 Product specification	74LVC623A v.3	20040506	Product specification	-	74LVC623A v.2					
	74LVC623A v.2	19980729	Product specification	-	-					

### Octal transceiver with dual enable; 3-state

# 15. Legal information

### 15.1 Data sheet status

Document status[1][2]	Product status[3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

- [1] Please consult the most recently issued document before initiating or completing a design
- [2] The term 'short data sheet' is explained in section "Definitions"
- [3] The product status of device(s) described in this document may have changed since this document was published and may differ in case of multiple devices. The latest product status information is available on the Internet at URL http://www.nxp.com.

### 15.2 Definitions

Draft — The document is a draft version only. The content is still under internal review and subject to formal approval, which may result in modifications or additions. NXP Semiconductors does not give any representations or warranties as to the accuracy or completeness of information included herein and shall have no liability for the consequences of use of such information.

Short data sheet — A short data sheet is an extract from a full data sheet with the same product type number(s) and title. A short data sheet is intended for quick reference only and should not be relied upon to contain detailed and full information. For detailed and full information see the relevant full data sheet, which is available on request via the local NXP Semiconductors sales office. In case of any inconsistency or conflict with the short data sheet, the full data sheet shall prevail.

**Product specification** — The information and data provided in a Product data sheet shall define the specification of the product as agreed between NXP Semiconductors and its customer, unless NXP Semiconductors and customer have explicitly agreed otherwise in writing. In no event however, shall an agreement be valid in which the NXP Semiconductors product is deemed to offer functions and qualities beyond those described in the Product data sheet.

### 15.3 Disclaimers

Limited warranty and liability — Information in this document is believed to be accurate and reliable. However, NXP Semiconductors does not give any representations or warranties, expressed or implied, as to the accuracy or completeness of such information and shall have no liability for the consequences of use of such information.

In no event shall NXP Semiconductors be liable for any indirect, incidental, punitive, special or consequential damages (including - without limitation - lost profits, lost savings, business interruption, costs related to the removal or replacement of any products or rework charges) whether or not such damages are based on tort (including negligence), warranty, breach of contract or any other legal theory.

Notwithstanding any damages that customer might incur for any reason whatsoever, NXP Semiconductors' aggregate and cumulative liability towards customer for the products described herein shall be limited in accordance with the *Terms and conditions of commercial sale* of NXP Semiconductors.

Right to make changes — NXP Semiconductors reserves the right to make changes to information published in this document, including without limitation specifications and product descriptions, at any time and without notice. This document supersedes and replaces all information supplied prior to the publication hereof.

**Suitability for use** — NXP Semiconductors products are not designed, authorized or warranted to be suitable for use in life support, life-critical or safety-critical systems or equipment, nor in applications where failure or

malfunction of an NXP Semiconductors product can reasonably be expected to result in personal injury, death or severe property or environmental damage. NXP Semiconductors accepts no liability for inclusion and/or use of NXP Semiconductors products in such equipment or applications and therefore such inclusion and/or use is at the customer's own risk.

**Applications** — Applications that are described herein for any of these products are for illustrative purposes only. NXP Semiconductors makes no representation or warranty that such applications will be suitable for the specified use without further testing or modification.

Customers are responsible for the design and operation of their applications and products using NXP Semiconductors products, and NXP Semiconductors accepts no liability for any assistance with applications or customer product design. It is customer's sole responsibility to determine whether the NXP Semiconductors product is suitable and fit for the customer's applications and products planned, as well as for the planned application and use of customer's third party customer(s). Customers should provide appropriate design and operating safeguards to minimize the risks associated with their applications and products.

NXP Semiconductors does not accept any liability related to any default, damage, costs or problem which is based on any weakness or default in the customer's applications or products, or the application or use by customer's third party customer(s). Customer is responsible for doing all necessary testing for the customer's applications and products using NXP Semiconductors products in order to avoid a default of the applications and the products or of the application or use by customer's third party customer(s). NXP does not accept any liability in this respect.

Limiting values — Stress above one or more limiting values (as defined in the Absolute Maximum Ratings System of IEC 60134) will cause permanent damage to the device. Limiting values are stress ratings only and (proper) operation of the device at these or any other conditions above those given in the Recommended operating conditions section (if present) or the Characteristics sections of this document is not warranted. Constant or repeated exposure to limiting values will permanently and irreversibly affect the quality and reliability of the device.

Terms and conditions of commercial sale — NXP Semiconductors products are sold subject to the general terms and conditions of commercial sale, as published at <a href="http://www.nxp.com/profile/terms">http://www.nxp.com/profile/terms</a>, unless otherwise agreed in a valid written individual agreement. In case an individual agreement is concluded only the terms and conditions of the respective agreement shall apply. NXP Semiconductors hereby expressly objects to applying the customer's general terms and conditions with regard to the purchase of NXP Semiconductors products by customer.

**No offer to sell or license** — Nothing in this document may be interpreted or construed as an offer to sell products that is open for acceptance or the grant, conveyance or implication of any license under any copyrights, patents or other industrial or intellectual property rights.

**Export control** — This document as well as the item(s) described herein may be subject to export control regulations. Export might require a prior authorization from competent authorities.

74LVC623A

### Octal transceiver with dual enable; 3-state

Non-automotive qualified products — Unless this data sheet expressly states that this specific NXP Semiconductors product is automotive qualified, the product is not suitable for automotive use. It is neither qualified nor tested in accordance with automotive testing or application requirements. NXP Semiconductors accepts no liability for inclusion and/or use of non-automotive qualified products in automotive equipment or applications.

In the event that customer uses the product for design-in and use in automotive applications to automotive specifications and standards, customer (a) shall use the product without NXP Semiconductors' warranty of the product for such automotive applications, use and specifications, and (b) whenever customer uses the product for automotive applications beyond

NXP Semiconductors' specifications such use shall be solely at customer's own risk, and (c) customer fully indemnifies NXP Semiconductors for any liability, damages or failed product claims resulting from customer design and use of the product for automotive applications beyond NXP Semiconductors' standard warranty and NXP Semiconductors' product specifications.

### 15.4 Trademarks

Notice: All referenced brands, product names, service names and trademarks are the property of their respective owners.

# 16. Contact information

For more information, please visit: http://www.nxp.com

For sales office addresses, please send an email to: salesaddresses@nxp.com

# Octal transceiver with dual enable; 3-state

# 17. Contents

1	General description
2	Features and benefits
3	Ordering information
4	Functional diagram 2
5	Pinning information 4
5.1	Pinning 4
5.2	Pin description 4
6	Functional description 5
7	Limiting values 5
8	Recommended operating conditions 6
9	Static characteristics 6
10	Dynamic characteristics
11	Waveforms
12	Package outline
13	Abbreviations
14	Revision history
15	Legal information
15.1	Data sheet status
15.2	Definitions
15.3	Disclaimers
15.4	Trademarks17
16	Contact information 17
17	Contents 18

Please be aware that important notices concerning this document and the product(s) described herein, have been included in section 'Legal information'.